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VS-GB75DA120UP

Vishay Semiconductors

Insulated Gate Bipolar Transistor (Ultrafast IGBT), 75 A



SOT-227

1200 V

75 A at 95 °C

3.3 V

SOT-227

PRODUCT SUMMARY

 $\mathsf{V}_{\mathsf{CES}}$

 $I_C DC$

V_{CE(on)} typical at 75 A, 25 °C

Package

FEATURES

- NPT Generation V IGBT technology
- Square RBSOA
- HEXFRED[®] low Q_{rr}, low switching energy
- Positive V_{CE(on)} temperature coefficient
- Fully isolated package
- Speed 8 kHz to 60 kHz
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting on heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		1200	V		
Continuous collector current		T _C = 25 °C	131			
Continuous collector current	Ι _C	T _C = 80 °C	89			
Pulsed collector current	I _{CM}		200	A		
Clamped inductive load current	I _{LM}		200	A		
Diode continuous forward current		T _C = 25 °C	59			
	I _F	T _C = 80 °C	39			
Gate to emitter voltage	V _{GE}		± 20	V		
Power dissipation, IGBT	_	T _C = 25 °C	658			
	P _D	T _C = 80 °C	369	1		
Power dissipation, diode		T _C = 25 °C	240	W		
	P _D	T _C = 80 °C	135	1		
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V		

Pb-free RoHS

COMPLIANT

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 250 \mu\text{A}$	1200	-	-			
Collector to omitter voltage	V	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 75 \text{ A}$	-	3.3	3.8	v		
Collector to emitter voltage	V _{CE(on)}	V_{GE} = 15 V, I_C = 75 A, T_J = 125 $^\circ C$	-	3.6	3.9			
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \ \mu A$	4	5	6			
Temperature coefficient of threshold voltage	$V_{GE(th)}/\Delta T_J$	V_{CE} = V_{GE} , I_C = 1 mA (25 °C to 125 °C)	-	- 12	-	mV/°C		
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 V, V_{CE} = 1200 V$	-	3	250	μA		
		V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 150 °C	-	4	20	mA		
Forward voltage drop		I _C = 75 A, V _{GE} = 0 V	-	3.4	5.0	V		
	V _{FM}	$I_{C} = 75 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	3.3	5.2	V		
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA		

PARAMETER	SYMBOL	TEST CONDI	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg		-	690	-		
Gate to emitter charge (turn-on)	Q _{ge}	$I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V, V	$I_{\rm C} = 50$ A, $V_{\rm CC} = 600$ V, $V_{\rm GE} = 15$ V				nC
Gate to collector charge (turn-on)	Q _{gc}		-	250	-		
Turn-on switching loss	E _{on}	L - 75 A V - 600 V	-	-	1.53	-	- mJ
Turn-off switching loss	E _{off}	$ I_{C} = 75 \text{ A}, V_{CC} = 600 \text{ V}, \\ V_{GE} = 15 \text{ V}, R_{g} = 5 \Omega, $		-	1.76	-	
Total switching loss	E _{tot}	L = 500 µH, T _J = 25 °C		-	3.29	-	
Turn-on switching loss	E _{on}		Energy leases	-	2.49	-	
Turn-off switching loss	E _{off}		Energy losses include tail and diode recovery (see fig. 18)	-	3.45	-	
Total switching loss	E _{tot}	I _C = 75 A, V _{CC} = 600 V, V _{GE} = 15 V, R _g = 5 Ω,		-	5.94	-	
Turn-on delay time	t _{d(on)}			-	281	-	- ns
Rise time	t _r	L = 500 μH, T _J = 125 °C		-	45	-	
Turn-off delay time	t _{d(off)}			-	300	-	
Fall time	t _f			-	126	-	
Reverse bias safe operating area	RBSOA	$\begin{split} T_J &= 150 \ ^\circ C, \ I_C &= 200 \ A, \\ V_{GE} &= 15 \ V \ to \ 0 \ V, \ V_{CC} &= \\ V_P &= 1200 \ V, \ L &= 500 \ \mu H \end{split}$		Fullsquare			
Diode reverse recovery time	t _{rr}			-	142	210	ns
Diode peak reverse current	l _{rr}	l _F = 50 A, dl _F /dt = 200 A/μs, V _R = 200 V - 13 16					А
Diode recovery charge	Q _{rr}	- 923 1680					
Diode reverse recovery time	t _{rr}					260	ns
Diode peak reverse current	l _{rr}	I _F = 50 A, dI _F /dt = 200 A V _R = 200 V, T _J = 125 °C	18	22	А		
Diode recovery charge	Q _{rr}	VH = 200 V, IJ = 120 O	-	1818	2860	nC	

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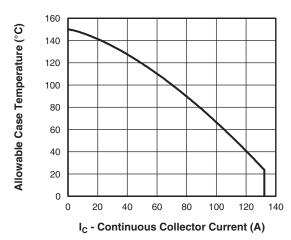


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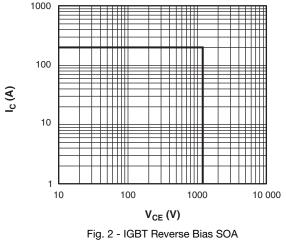
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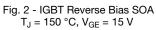
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THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range		T _J , T _{Stg}		- 40	-	150	°C
Junction to case	IGBT	- R _{thJC}		-	-	0.19	
	Diode			-	-	0.52	°C/W
Case to heatsink		R _{thCS}	Flat, greased surface	-	0.05	-	
Weight				-	30	-	g
Mounting torque				-	-	1.3	Nm
Case style			SOT-227				









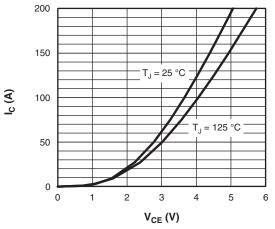
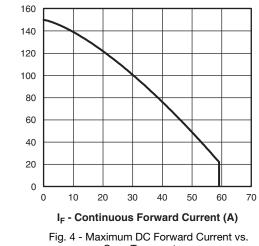


Fig. 3 - Typical IGBT Collector Current Characteristics



Case Temperature

Allowable Case Temperature (°C)

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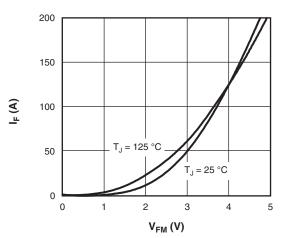


Fig. 5 - Typical Diode Forward Characteristics

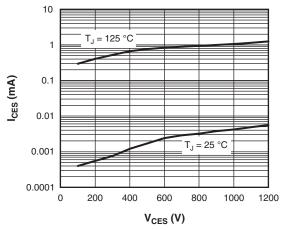


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

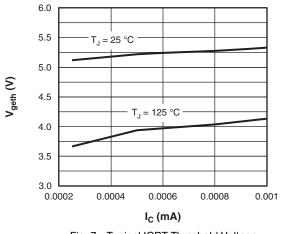


Fig. 7 - Typical IGBT Threshold Voltage

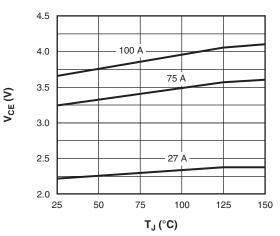


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature, V_{GE} = 15 V

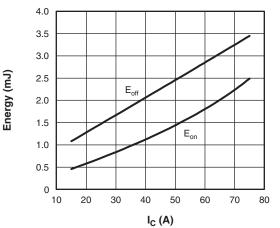
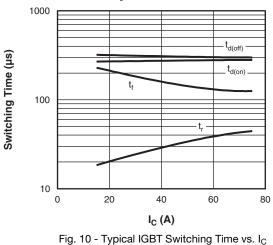
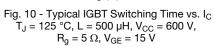


Fig. 9 - Typical IGBT Energy Loss vs. I_C T_J = 125 °C, L = 500 μ H, V_{CC} = 600 V, R_g = 5 Ω , V_{GE} = 15 V





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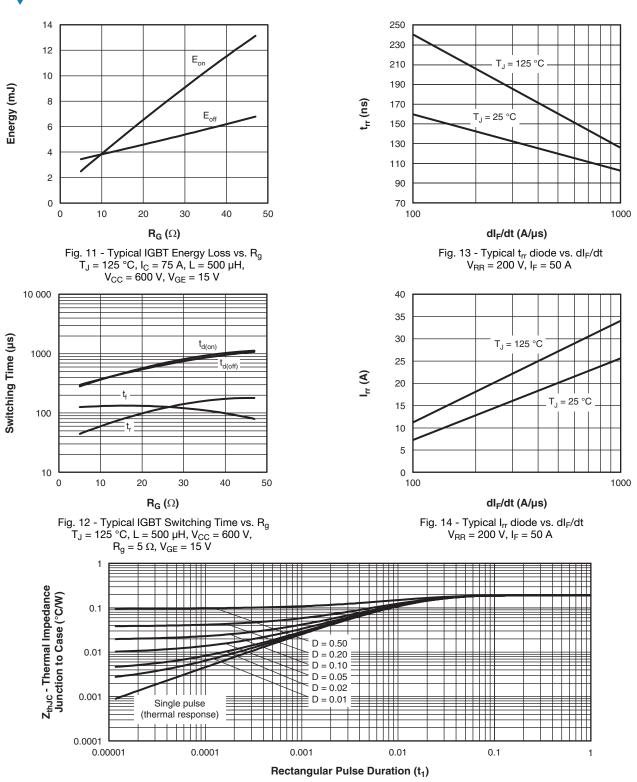


Fig. 15 - Maximum Thermal Impedance ZthJC Characteristics (IGBT)

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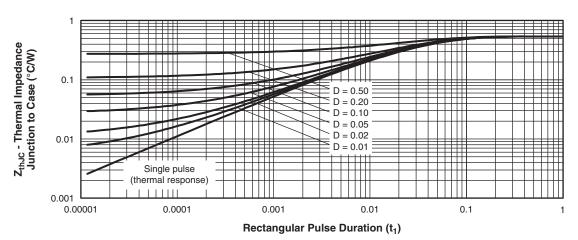
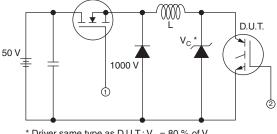


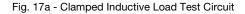
Fig. 16 - Maximum Thermal Impedance Z_{thJC} Characteristics (diode)



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 ^{*} Driver same type as D.U.T.; V_C = 80 % of V_{ce(max)}
* Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id



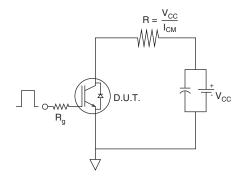


Fig. 17b - Pulsed Collector Current Test Circuit

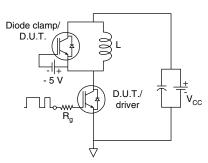


Fig. 18a - Switching Loss Test Circuit



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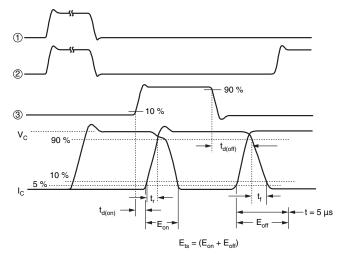
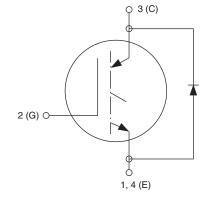


Fig. 18b - Switching Loss Waveforms Test Circuit

ORDERING INFORMATION TABLE

Device code	VS-	G	В	75	D	Α	120	U	Ρ	
	1	2	3	4	5	6	7	8	9	I
	1 -	Visł	nay Sem	nicondu	ctors pro	oduct				
	2 -	Insu	lated G	ate Bipo	olar Trar	nsistor (IGBT)			
	3 -	3 - B = IGBT Generation 5								
	4 -	4 - Current rating (75 = 75 A)								
	5 -	- Circuit configuration (D = Single switch with antiparallel diod							ode)	
	6 -	- Package indicator (A = SOT-227)								
	7 -	- Voltage rating (120 = 1200 V)								
	8 -	- Speed/type (U = Ultrafast IGBT)								
	9 -	9 - Totally lead (Pb)-free								

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95036				
Packaging information	www.vishay.com/doc?95037				
Revision: 30- Jul-13	- Document Number: 9301				

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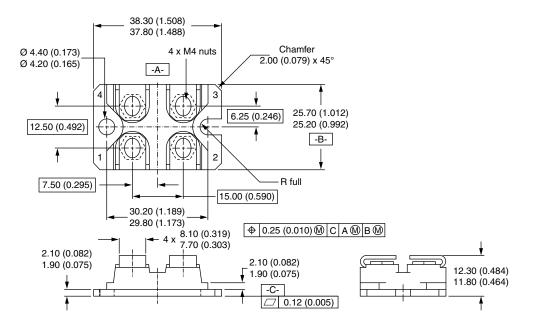


Outline Dimensions

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SOT-227

DIMENSIONS in millimeters (inches)



Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



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